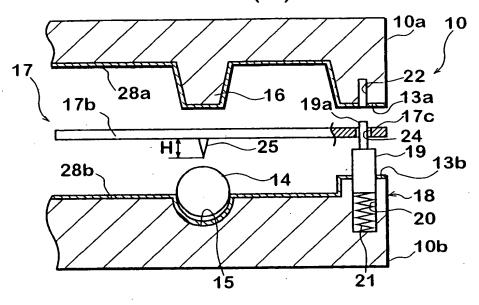
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FIG. 1 (A)



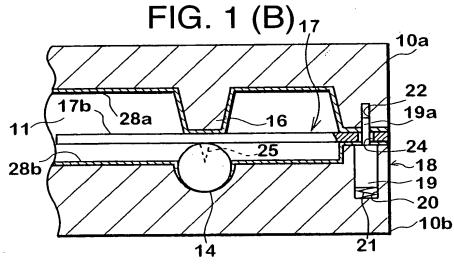
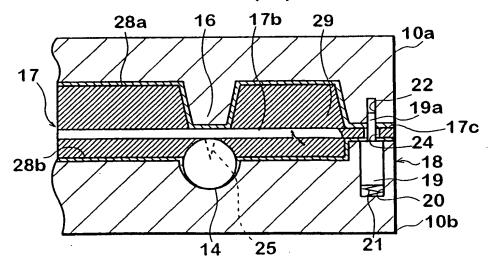


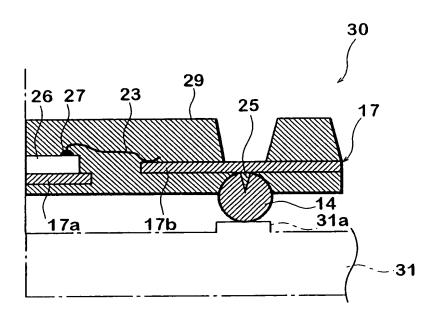
FIG. 1 (C)



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Title: SEMICONDUCTOR PACKAGE.....
Filed: December 20, 2001
6 sheets of drawings FIGS.1A-7C
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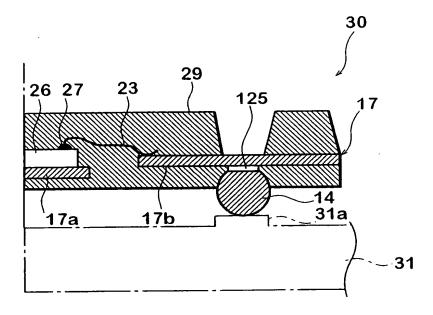




PACKAGE (1)

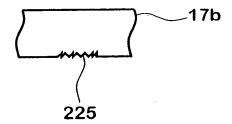
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FIG. 4



PACKAGE (2)

FIG. 5



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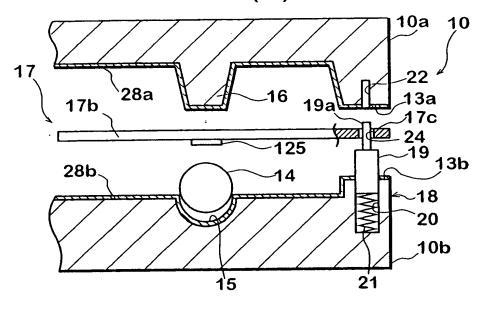
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4.1 4.1 6.1 6.1

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FIG. 3(A)



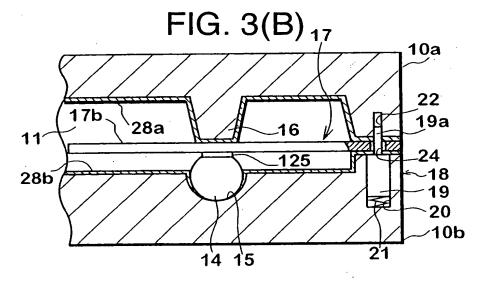


FIG. 3(C)

28a 16 17b 29

10a

222

19a

17c

28b

14 125 21

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6 sh of drawings FIGS.1A-7C
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FIG. 6(A)

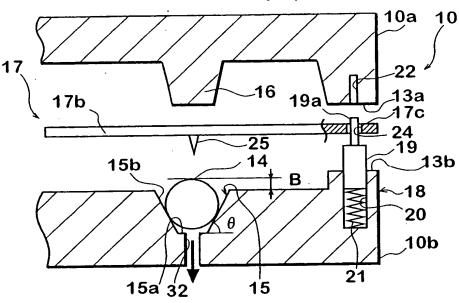


FIG. 6(B)

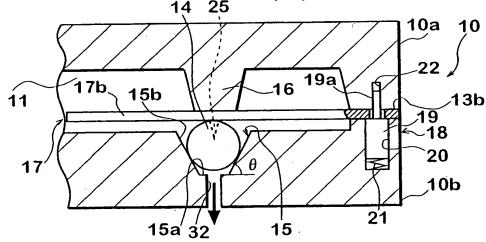
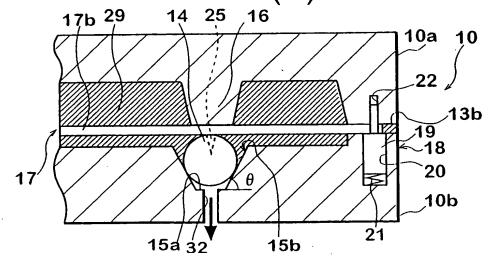


FIG. 6(C)



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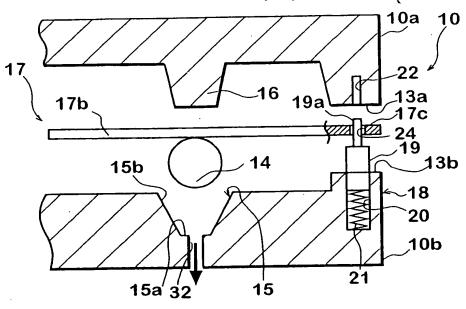


FIG. 7(B)

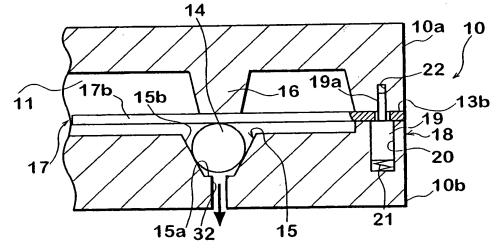


FIG. 7(C)

